RILV0416D Series

4M SRAM (256-kword × 16-bit)

REJ03C0311-0100 Rev.1.00 May.24.2007

Description

The R1LV0416D is a 4-Mbit static RAM organized 256-kword \times 16-bit, fabricated by Renesas's high-performance 0.15µm CMOS and TFT technologies. R1LV0416D Series has realized higher density, higher performance and low power consumption. The R1LV0416D Series offers low power standby power dissipation; therefore, it is suitable for battery backup systems. The R1LV0416D Series is packaged in a 44-pin thin small outline mount device, or a 48-ball fine pitch ball grid array.

Features

- Single 3.0 V supply: 2.7 V to 3.6 V
- Fast access time: 55/70 ns (max)
- Power dissipation:
 - Standby: $3 \mu W (typ) (V_{cc} = 3.0 V)$
- Equal access and cycle times
- Common data input and output.
 - Three state output
- Battery backup operation.
 - 2 chip selection for battery backup
- Temperature Range: -40 to +85°C

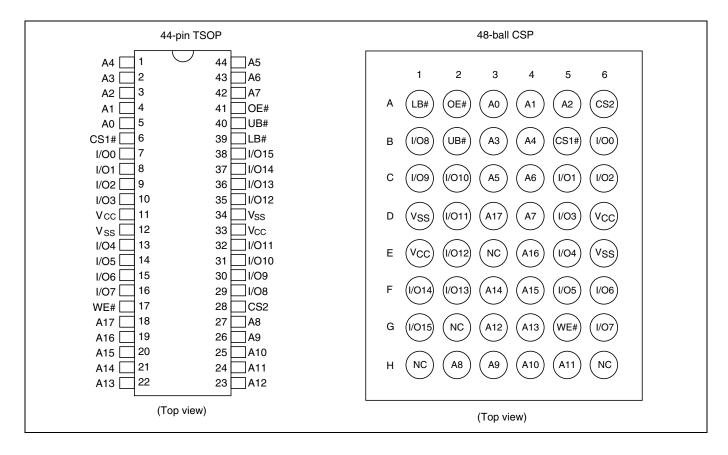


Ordering Information

Type No.	Access time	Package
R1LV0416DSB-5SI	55 ns	400-mil 44-pin plastic TSOP II
R1LV0416DSB-7LI	70 ns	PTSB0044GA-A (44P3W-H)
R1LV0416DBG-5SI	55 ns	48-ball CSP with 0.75 mm ball pitch
R1LV0416DBG-7LI	70 ns	PTBG0048HB-A (48FHH)



Pin Arrangement

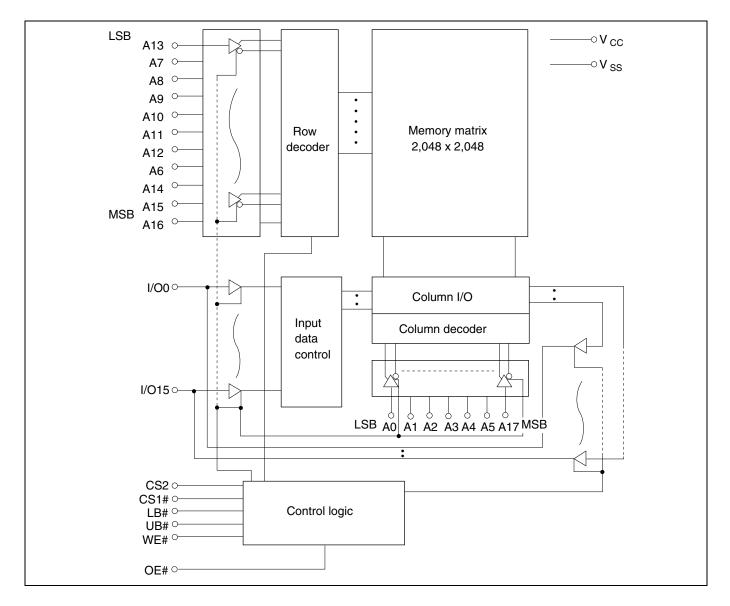


Pin Description

Pin name	Function
A0 to A17	Address input
I/O0 to I/O15	Data input/output
CS1# (CS1)	Chip select 1
CS2	Chip select 2
OE# (OE)	Output enable
WE# (WE)	Write enable
LB# (LB)	Lower byte select
UB# (UB)	Upper byte select
V _{cc}	Power supply
V _{ss}	Ground
NC	No connection



Block Diagram



Operation Table

CS1#	CS2	WE#	OE#	UB#	LB#	I/O0 to I/O7	I/O8 to I/O15	Operation
Н	×	×	×	×	×	High-Z	High-Z	Standby
×	L	×	×	×	×	High-Z	High-Z	Standby
×	×	×	×	Н	Н	High-Z	High-Z	Standby
L	Н	Н	L	L	L	Dout	Dout	Read
L	Н	Н	L	Н	L	Dout	High-Z	Lower byte read
L	Н	Н	L	L	Н	High-Z	Dout	Upper byte read
L	Н	L	×	L	L	Din	Din	Write
L	Н	L	×	Н	L	Din	High-Z	Lower byte write
L	Н	L	×	L	Н	High-Z	Din	Upper byte write
L	Н	Н	Н	×	×	High-Z	High-Z	Output disable

Note: H: V_{IH} , L: V_{IL} , \times : V_{IH} or V_{IL}

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Power supply voltage relative to V_{ss}	V _{cc}	–0.5 to +4.6	V
Terminal voltage on any pin relative to V_{ss}	V _T	-0.5^{*1} to V _{cc} + 0.3 ^{*2}	V
Power dissipation	P _T	0.7	W
Operating temperature1	Topr	-40 to +85	°C
Storage temperature range	Tstg	-65 to +150	°C
Storage temperature range under bias	Tbias	-40 to +85	°C

Notes: 1. V_{T} min: -3.0 V for pulse half-width \leq 30 ns.

2. Maximum voltage is +4.6 V.

DC Operating Conditions

Parameter	Symbol	Min	Тур	Max	Unit	Note
Supply voltage	V _{cc}	2.7	3.0	3.6	V	
	V _{ss}	0	0	0	V	
Input high voltage	V _{IH}	2.2	_	V _{cc} + 0.3	V	
Input low voltage	V	-0.3	_	0.6	V	1
Ambient temperature range	Та	-40		+85	°C	

Note: 1. V_{\parallel} min: -3.0 V for pulse half-width \leq 30 ns.

DC Characteristics

Parameter			Symbol	Min	Тур	Max	Unit	Test conditions
Input leakage current			I _L	_	—	1	μA	$Vin = V_{ss} to V_{cc}$
Output leakage current			I _{LO}	—		1	μA	$CS1\# = V_{\mu} \text{ or } CS2 = V_{\mu} \text{ or}$ $OE\# = V_{\mu} \text{ or } WE\# = V_{\mu} \text{ or}$ $LB\# = UB\# = V_{\mu},$ $V_{\nu o} = V_{ss} \text{ to } V_{cc}$
Operating current			I _{cc}	—		20	mA	$\begin{split} &CS1\#=V_{\tiny L }, CS2=V_{\tiny H },\\ &Others=V_{\tiny H }/V_{\tiny L }, \ I_{\tiny VO}=0\ mA \end{split}$
Average operating current			I _{cc1}			25	mA	Min. cycle, duty = 100%, $I_{\nu 0} = 0 \text{ mA}, \text{ CS1} \# = V_{\mu},$ $\text{CS2} = V_{\mu},$ $\text{Others} = V_{\mu}/V_{\mu}$
			I _{cc2}			5	mA	$\begin{array}{l} \mbox{Cycle time} = 1 \ \mbox{\mu s}, \\ \mbox{duty} = 100\%, \\ \mbox{I}_{_{UO}} = 0 \ \mbox{mA}, \ \mbox{CS1} \# \leq 0.2 \ \mbox{V}, \\ \mbox{CS2} \geq V_{_{CC}} - 0.2 \ \mbox{V} \\ \mbox{V}_{_{IH}} \geq V_{_{CC}} - 0.2 \ \mbox{V}, \\ \mbox{V}_{_{IL}} \leq 0.2 \ \mbox{V} \end{array}$
Standby current			I _{SB}	—	0.1* ¹	0.3	mA	CS2 = V _{IL}
Standby current	–5SI	to +85°C	I _{SB1}			10	μA	$Vin \ge 0 V$
		to +70°C	I _{SB1}	—	_	8	μA	(1) 0 V \leq CS2 \leq 0.2 V or
		to +40°C	I _{SB1}	_	_	3	μA	(2) CS1# \ge V _{cc} – 0.2 V,
		to +25°C	I _{SB1}		1 * ¹	2.5	μA	$CS2 \ge V_{cc} - 0.2 V \text{ or}$
	–7LI	to +85°C	I _{SB1}	—	—	20	μA	(3) LB# = UB# \ge V _{cc} – 0.2 V,
		to +70°C	I _{SB1}		_	16	μA	$\text{CS2} \ge \text{V}_{\text{cc}} - 0.2 \text{ V},$
		to +40°C	I _{SB1}		_	10	μA	CS1# ≤ 0.2 V
to +25°C		I _{SB1}		1 * ¹	10	μA	Average values	
Output high voltage		V _{OH}	2.4	_	—	V	I _{он} = –1 mA	
			V _{OH2}	$V_{\rm cc} - 0.2$		—	V	I _{oн} = -100 μA
Output low voltage			V _{oL}	—	_	0.4	V	$I_{oL} = 2 \text{ mA}$
			V _{OL2}	—	_	0.2	V	I _{oL} = 100 μA

Note: 1. Typical values are at $V_{cc} = 3.0 \text{ V}$, Ta = +25°C and specified loading, and not guaranteed.

Capacitance

 $(Ta = +25^{\circ}C, f = 1.0 \text{ MHz})$

Parameter	Symbol	Min	Тур	Max	Unit	Test conditions	Note
Input capacitance	Cin		—	8	pF	Vin = 0 V	1
Input/output capacitance	C _{I/O}			10	pF	$V_{I/O} = 0 V$	1

Note: 1. This parameter is sampled and not 100% tested.

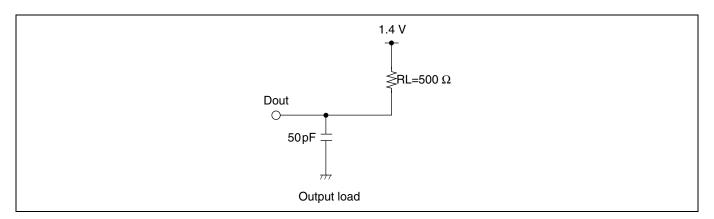
AC Characteristics

(Ta = -40 to +85°C, V_{cc} = 2.7 V to 3.6 V)

Test Conditions

Input pulse levels: $V_{IL} = 0.4 \text{ V}, V_{IH} = 2.4 \text{ V}$

- Input rise and fall time: 5 ns
- Input/output timing reference levels: 1.4 V
- Output load: See figures (Including scope and jig)





R1LV0416D Series

Read Cycle

			R1LV	0416D				
		-5	SI	-7	'LI			
Parameter	Symbol	Min	Max	Min	Max	Unit	Notes	
Read cycle time	t _{RC}	55	—	70		ns		
Address access time	t _{AA}	—	55	_	70	ns		
Chip select access time	t _{ACS1}	—	55	—	70	ns		
	t _{ACS2}	—	55	_	70	ns		
Output enable to output valid	t _{oe}	_	35	_	40	ns		
Output hold from address change	t _{on}	10	—	10		ns		
LB#, UB# access time	t _{BA}	—	55	—	70	ns		
Chip select to output in low-Z	t _{cLZ1}	10		10		ns	2, 3	
	t _{cl.Z2}	10		10		ns	2, 3	
LB#, UB# disable to low-Z	t _{BLZ}	5	—	5		ns	2, 3	
Output enable to output in low-Z	t _{oLZ}	5		5		ns	2, 3	
Chip deselect to output in high-Z	t _{cHZ1}	0	20	0	25	ns	1, 2, 3	
	t _{CHZ2}	0	20	0	25	ns	1, 2, 3	
LB#, UB# disable to high-Z	t _{BHZ}	0	20	0	25	ns	1, 2, 3	
Output disable to output in high-Z	t _{oHZ}	0	20	0	25	ns	1, 2, 3	



Write Cycle

			R1LV				
		-5	SI	-7	'LI	1	
Parameter	Symbol	Min Max		Min	Max	Unit	Notes
Write cycle time	t _{wc}	55		70	_	ns	
Address valid to end of write	t _{AW}	50		60	_	ns	
Chip selection to end of write	t _{cw}	50	—	60	_	ns	5
Write pulse width	t _{wP}	40		50	_	ns	4
LB#, UB# valid to end of write	t _{BW}	50	—	55	_	ns	
Address setup time	t _{AS}	0		0	_	ns	6
Write recovery time	t _{wR}	0	—	0	—	ns	7
Data to write time overlap	t _{DW}	25	—	30	—	ns	
Data hold from write time	t _{DH}	0		0	_	ns	
Output active from end of write	t _{ow}	5	—	5	_	ns	2
Output disable to output in high-Z	t _{ohz}	0	20	0	25	ns	1, 2, 3
Write to output in high-Z	t _{wHZ}	0	20	0	25	ns	1, 2

Notes: 1. t_{CHZ} , t_{OHZ} ,

2. This parameter is sampled and not 100% tested.

3. At any given temperature and voltage condition, t_{HZ} max is less than t_{LZ} min both for a given device and from device to device.

4. A write occurs during the overlap of a low CS1#, a high CS2, a low WE# and a low LB# or a low UB#. A write begins at the latest transition among CS1# going low, CS2 going high, WE# going low and LB# going low or UB# going low. A write ends at the earliest transition among CS1# going high, CS2 going low, WE# going low, WE# going high and LB# going high or UB# going high. t_{wP} is measured from the beginning of write to the end of write.

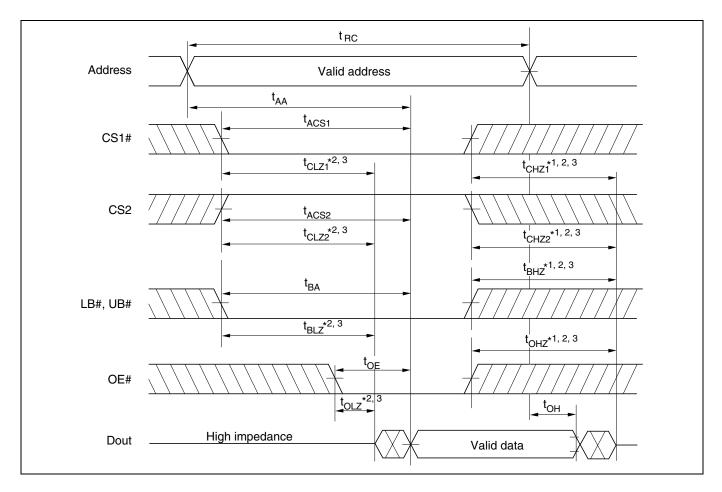
5. t_{cw} is measured from the later of CS1# going low or CS2 going high to the end of write.

6. t_{AS} is measured from the address valid to the beginning of write.

7. t_{we} is measured from the earliest of CS1# or WE# going high or CS2 going low to the end of write cycle.

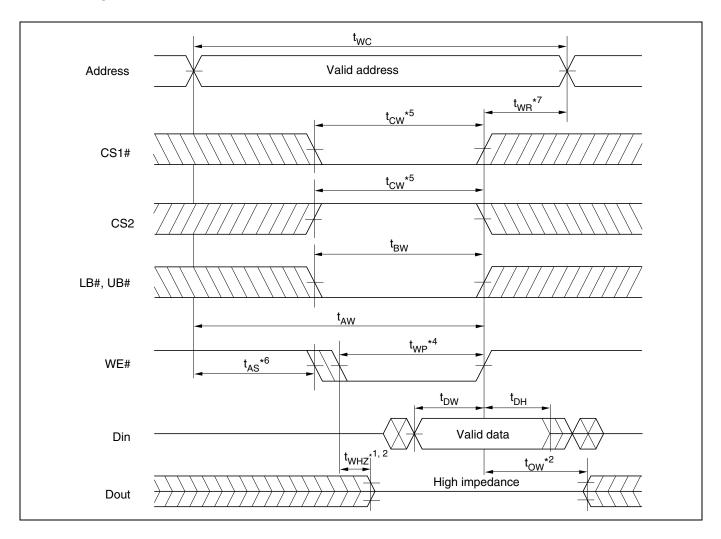
Timing Waveform

Read Timing Waveform (WE# = V_{III})



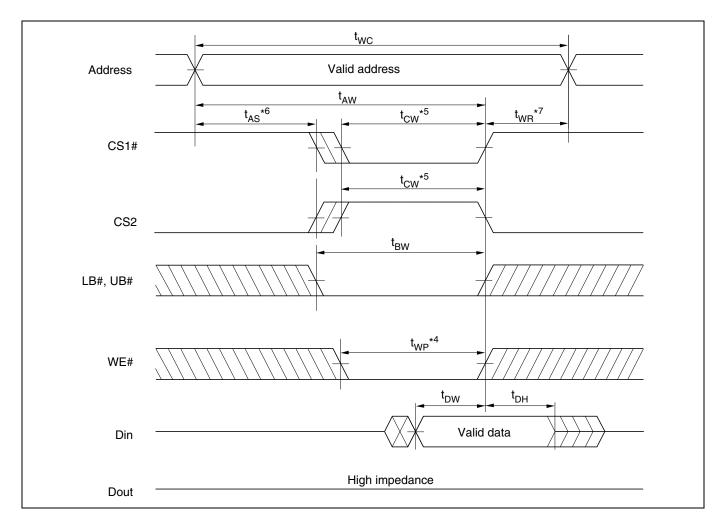


Write Timing Waveform (1) (WE# Clock)



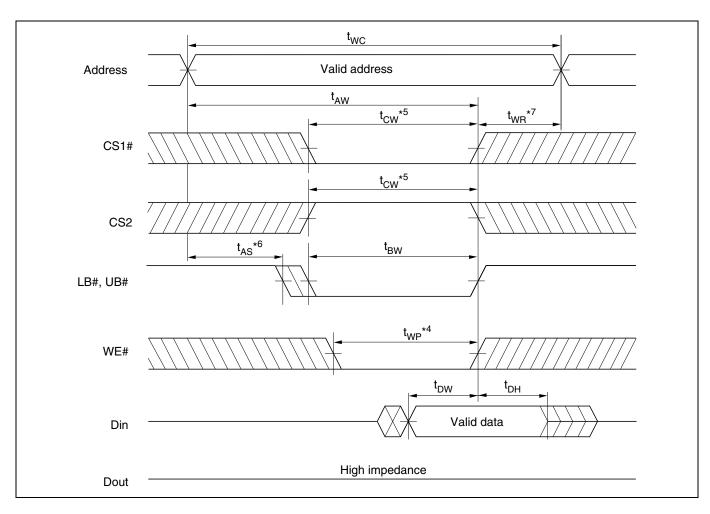
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Write Timing Waveform (2) (CS# Clock, $OE# = V_{IH}$)





Write Timing Waveform (3) (LB#, UB# Clock, $OE# = V_{IH}$)





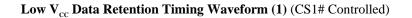
Low \mathbf{V}_{cc} Data Retention Characteristics

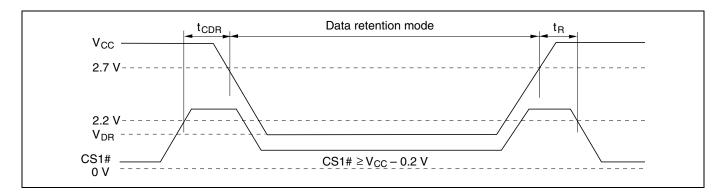
 $(Ta = -40 \text{ to } +85^{\circ}\text{C})$

	Parar	neter	Symbol	Min	Тур	Max	Unit	Test conditions
$V_{\rm cc}$ for data retention			V _{DR}	2.0			V	$ \begin{array}{l} \mbox{Vin} \geq 0\mbox{V} \\ (1) \ 0 \ V \leq CS2 \leq 0.2 \ V \ or \\ (2) \ CS2 \geq V_{_{CC}} - 0.2 \ V, \\ \ CS1\# \geq V_{_{CC}} - 0.2 \ V \ or \\ (3) \ LB\# = UB\# \geq V_{_{CC}} - 0.2 \ V, \\ \ CS2 \geq V_{_{CC}} - 0.2 \ V, \\ \ CS1\# \leq 0.2 \ V \\ \end{array} $
Data	-5SI	to +85°C	I _{CCDR}			10	μA	$V_{cc} = 3.0 \text{ V}, \text{ Vin} \ge 0 \text{ V}$
retention current		to +70°C			_	8	μA	(1) $0 V \le CS2 \le 0.2 V \text{ or}$ (2) $CS2 \ge V_{cc} - 0.2 V$,
ourronn		to +40°C		_	—	3	μA	$CS1 # \ge V_{cc} - 0.2 V \text{ or}$
		to +25°C			1 * ¹	2.5	μA	(3) $LB# = UB# \ge V_{cc} - 0.2 V,$
	–7LI	to +85°C	I _{CCDR}	—	—	20	μA	$\label{eq:cs2} \begin{split} & \text{CS2} \geq \text{V}_{\text{cc}} - 0.2 \text{ V}, \\ & \text{CS1} \# \leq 0.2 \text{ V} \end{split}$
		to +70°C	I _{CCDR}	—	—	16	μA	Average values
		to +40°C	I _{CCDR}	—	—	10	μA	
to +25		to +25°C	I _{CCDR}		1 * ¹	10	μA	
Chip deselect to data retention time		t _{cdr}	0			ns	See retention waveform	
Operation r	ecovery time	9	t _R	5			ms	

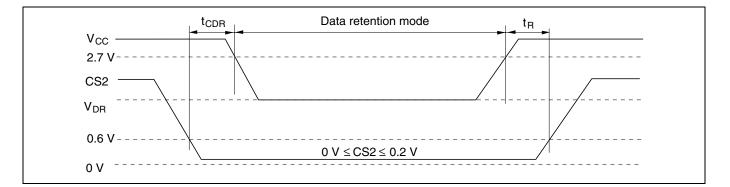
Note: 1. Typical values are at $V_{cc} = 3.0 \text{ V}$, Ta = +25°C and specified loading, and not guaranteed.



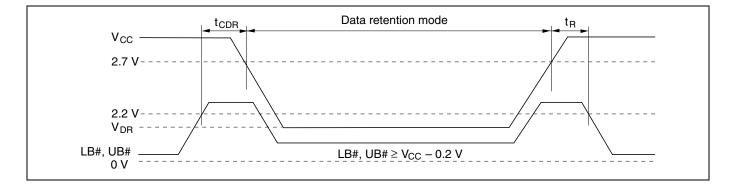




Low V_{cc} Data Retention Timing Waveform (2) (CS2 Controlled)



Low $V_{\rm cc}$ Data Retention Timing Waveform (3) (LB#, UB# Controlled)



Rev.	Date		Contents of Modification	
		Page	Description	
0.01	Dec. 25, 2006	_	Initial issue	
1.00	May. 24, 2007	2	Ordering Information	
			R1LV0416DSB-5S% to R1LV0416DSB-5SI	
			R1LV0416DSB-7L% to R1LV0416DSB-7LI	
			R1LV0416DBG-5S% to R1LV0416DBG-5SI	
			R1LV0416DBG-7L% to R1LV0416DBG-7LI	
		3	Pin Arrangement	
			A6 to A13, A13 to A6	
		4	Change of Block Diagram	
		5	Absolute Maximum Ratings: Deletion of R ver. specification	
		5	DC Operating Conditions: Deletion of R ver. specification	
		6	DC Characteristics	
			I _{SB1} (-5SI) (to +25°C) max: 3 μA to 2.5 μA	
		7	AC Characteristics: Change of Test Conditions	
		14	Low V _{CC} Data Retention Characteristics	
			I _{CCDR} (-5SI) (to +25°C) max: 3 μA to 2.5 μA	
			Deletion of note 2	

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